

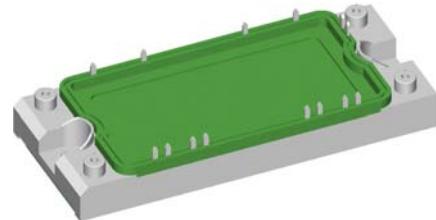
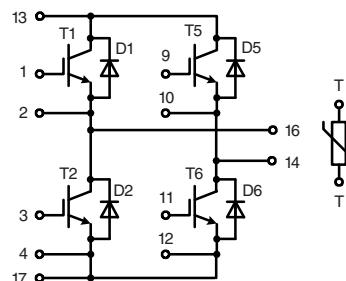
IGBT Modules

H-Bridge

Short Circuit SOA Capability
Square RBSOA

I_{C25} = 72 A
 V_{CES} = 600 V
 $V_{CE(sat)\text{typ.}}$ = 1.9 V

Type	NTC - Option
MKI 50-06 A7	without NTC
MKI 50-06 A7T	with NTC



IGBTs

Symbol	Conditions	Maximum Ratings		
V_{CES}	$T_{VJ} = 25^\circ\text{C}$ to 150°C	600	V	
V_{GES}		± 20	V	
I_{C25}	$T_C = 25^\circ\text{C}$	72	A	
I_{C80}	$T_C = 80^\circ\text{C}$	50	A	
RBSOA	$V_{GE} = \pm 15 \text{ V}$; $R_G = 22 \Omega$; $T_{VJ} = 125^\circ\text{C}$ Clamped inductive load; $L = 100 \mu\text{H}$	$I_{CM} = 100$ $V_{CEK} \leq V_{CES}$	A	
t_{sc} (SCSOA)	$V_{CE} = V_{CES}$; $V_{GE} = \pm 15 \text{ V}$; $R_G = 22 \Omega$; $T_{VJ} = 125^\circ\text{C}$ non-repetitive	10	μs	
P_{tot}	$T_C = 25^\circ\text{C}$	225	W	

Symbol	Conditions	Characteristic Values		
		($T_{VJ} = 25^\circ\text{C}$, unless otherwise specified)		
$V_{CE(sat)}$	$I_C = 50 \text{ A}$; $V_{GE} = 15 \text{ V}$; $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	1.9 2.2	2.4 V	V
$V_{GE(\text{th})}$	$I_C = 1 \text{ mA}$; $V_{GE} = V_{CE}$	4.5	6.5	V
I_{CES}	$V_{CE} = V_{CES}$; $V_{GE} = 0 \text{ V}$; $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	0.7	0.6 mA mA	
I_{GES}	$V_{CE} = 0 \text{ V}$; $V_{GE} = \pm 20 \text{ V}$		200 nA	
$t_{d(on)}$ t_r $t_{d(off)}$ t_f E_{on} E_{off}	$\left. \begin{array}{l} \text{Inductive load, } T_{VJ} = 125^\circ\text{C} \\ V_{CE} = 300 \text{ V}; I_C = 50 \text{ A} \\ V_{GE} = \pm 15 \text{ V}; R_G = 22 \Omega \end{array} \right\}$	50 60 300 30 2.3 1.7	ns ns ns ns mJ mJ	
C_{ies}		2800	pF	
Q_{Gon}		120	nC	
R_{thJC}			0.55	K/W

IXYS reserves the right to change limits, test conditions and dimensions.

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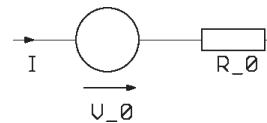
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Diodes				
Symbol	Conditions	Maximum Ratings		
I_{F25}	$T_c = 25^\circ\text{C}$	72	A	
I_{F80}	$T_c = 80^\circ\text{C}$	45	A	
		Characteristic Values		
		min.	typ.	max.
V_F	$I_F = 50 \text{ A}; V_{GE} = 0 \text{ V}; T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	1.6 1.3	1.8 V	V
I_{RM} t_{rr}	$\left. \begin{array}{l} I_F = 30 \text{ A}; dI_F/dt = -500 \text{ A}/\mu\text{s}; T_{VJ} = 125^\circ\text{C} \\ V_R = 300 \text{ V}; V_{GE} = 0 \text{ V} \end{array} \right\}$	25 90	A ns	A ns
R_{thJC}	(per diode)		1.19	K/W
Module				
Symbol	Conditions	Maximum Ratings		
T_{VJ}		-40...+150	$^\circ\text{C}$	
T_{stg}		-40...+125	$^\circ\text{C}$	
V_{ISOL}	$I_{ISOL} \leq 1 \text{ mA}; 50/60 \text{ Hz}$	2500	V~	
M_d	Mounting torque (M5)	2.7 - 3.3	Nm	
		Characteristic Values		
		min.	typ.	max.
$R_{pin-chip}$		5	$\text{m}\Omega$	
d_s	Creepage distance on surface	6		mm
d_A	Strike distance in air	6		mm
R_{thCH}	with heatsink compound	0.02		K/W
Weight		180	g	

Equivalent Circuits for Simulation

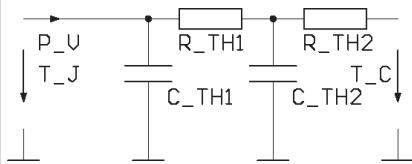
Conduction



IGBT (typ. at $V_{GE} = 15$ V; $T_J = 125^\circ\text{C}$)
 $V_0 = 0.82$ V; $R_0 = 28$ mΩ

Free Wheeling Diode (typ. at $T_J = 125^\circ\text{C}$)
 $V_o = 0.89 \text{ V}; R_o = 8 \text{ m}\Omega$

Thermal Response

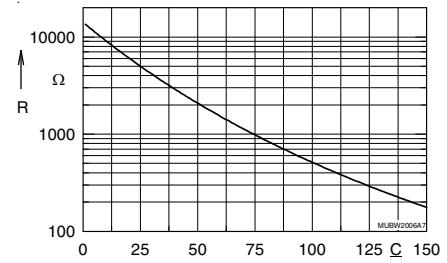


IGBT (typ.)

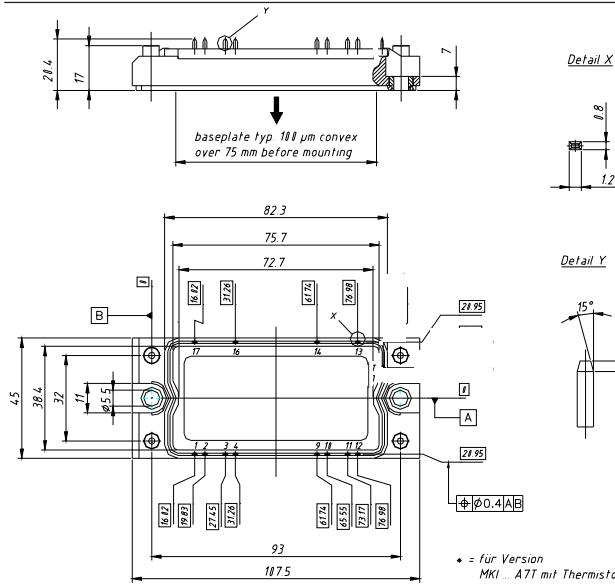
$$C_{th1} = 0.201 \text{ J/K}; R_{th1} = 0.42 \text{ K/W}$$

$$C_{th1} = 0.116 \text{ J/K}; R_{th1} = 0.973 \text{ KW}$$

$$C_{th2} = 0.88 \text{ J/K}; R_{th2} = 0.277 \text{ KW}$$



Typ. thermistor resistance versus temperature



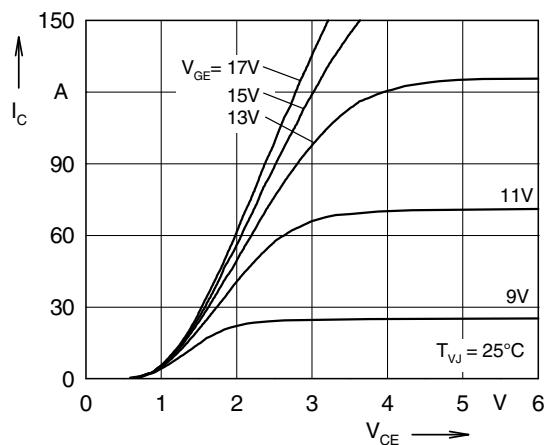


Fig. 1 Typ. output characteristics

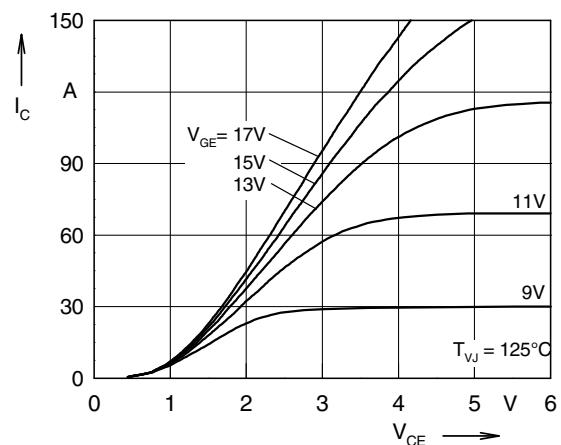


Fig. 2 Typ. output characteristics

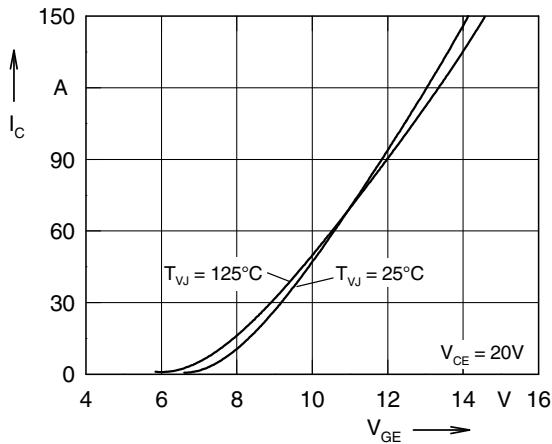


Fig. 3 Typ. transfer characteristics

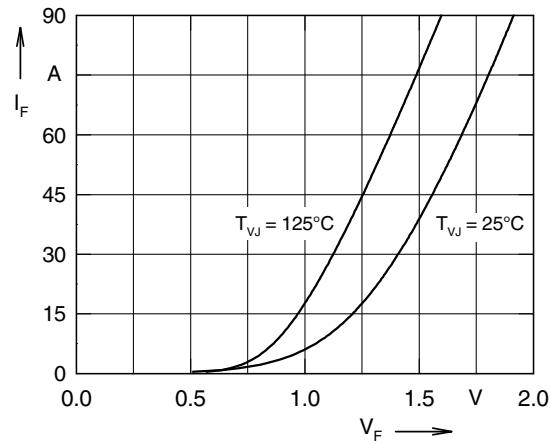


Fig. 4 Typ. forward characteristics of free wheeling diode

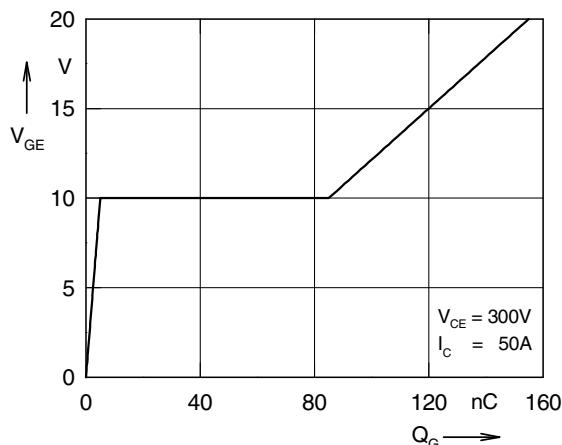


Fig. 5 Typ. turn on gate charge

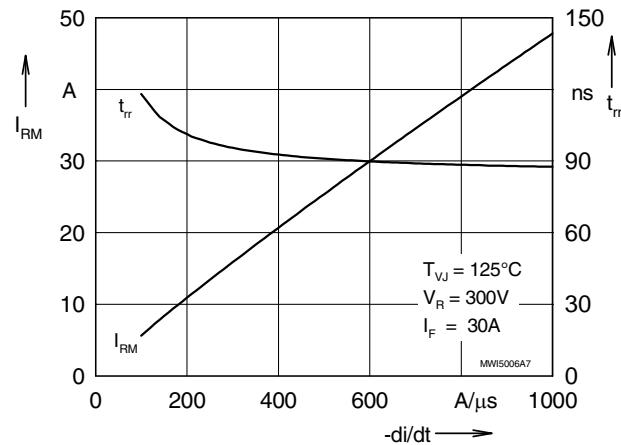


Fig. 6 Typ. turn off characteristics of free wheeling diode

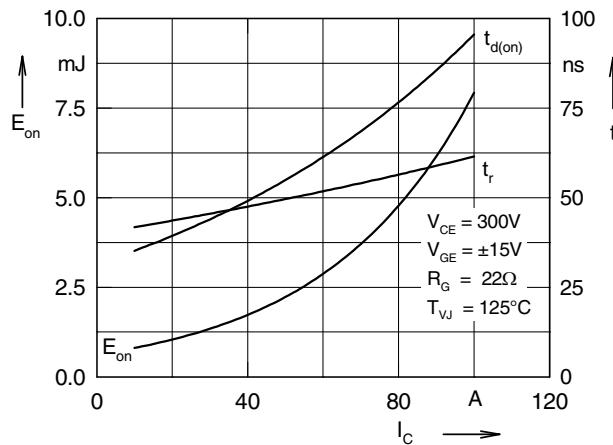


Fig. 7 Typ. turn on energy and switching times versus collector current

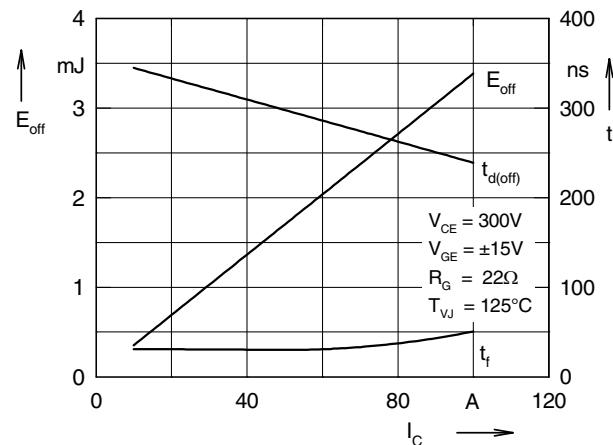


Fig. 8 Typ. turn off energy and switching times versus collector current

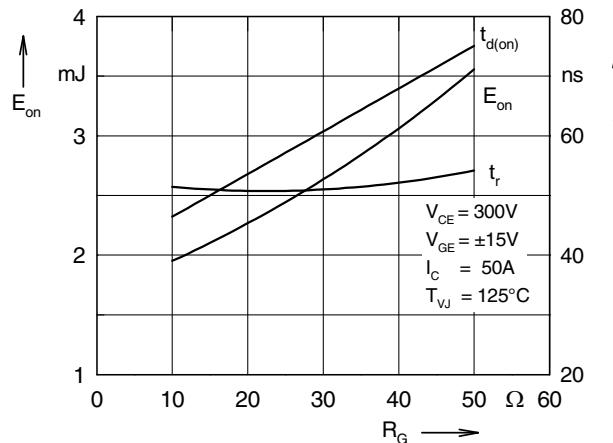


Fig. 9 Typ. turn on energy and switching times versus gate resistor

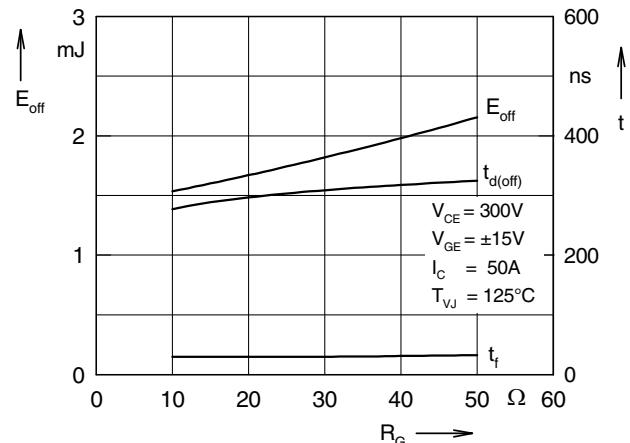


Fig. 10 Typ. turn off energy and switching times versus gate resistor

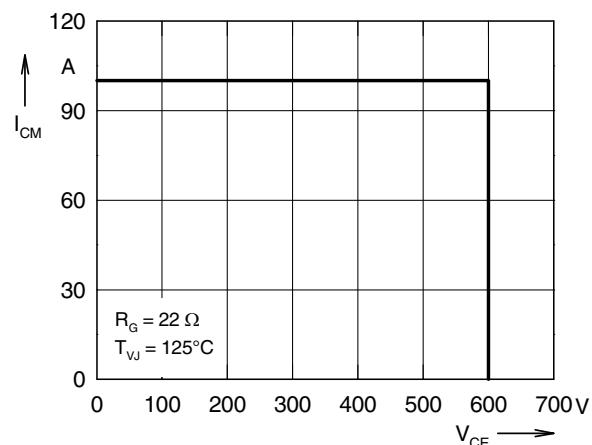


Fig. 11 Reverse biased safe operating area RBSOA

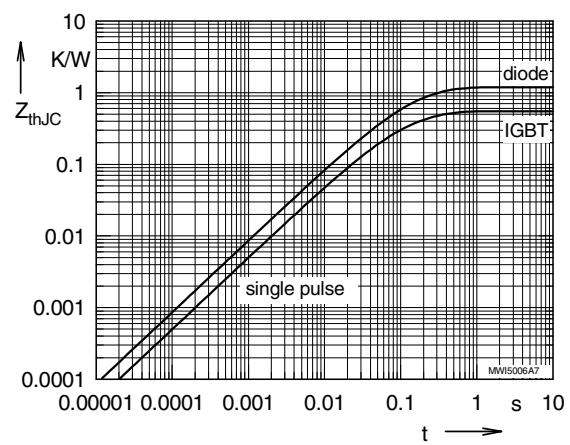


Fig. 12 Typ. transient thermal impedance